

Input, output data and efficiency: (room ambient temperature)
Channel 1: UCD74110 + Susumu PCMB104T-R36MT 960 and 480kHz
Power drawn by UCD9244 and Test interface (83mA off 5Vin) not included

Vin Volts	Iin A	Vout Volts	Iout A	% Efficiency	Losses in W
960	kHz	operation			
5.01	3.487	1.014	15.07	87.5	2.189
5.01	2.869	1.014	12.57	88.7	1.628
5.01	2.273	1.014	10.07	89.7	1.177
5.01	1.695	1.014	7.56	90.3	0.826
5.00	1.139	1.014	5.07	90.3	0.554
5.00	0.5945	1.014	2.57	87.7	0.367
5.03	0.2945	1.014	1.17	80.1	0.295
5.05	0.046	1.014	0	N/A	0.232
480	kHz	operation			
5.03	3.421	1.014	15.07	88.8	1.927
5.01	2.826	1.013	12.57	89.9	1.425
5.05	2.2195	1.013	10.07	91.0	1.008
5.01	1.6665	1.013	7.56	91.7	0.691
5.05	1.1045	1.013	5.07	92.1	0.442
5.01	0.576	1.013	2.57	90.2	0.282
5.04	0.278	1.013	1.17	84.6	0.216
5.01	0.0365	1.013	0	N/A	0.183

Qq

Dynamic step load and load dump:

Processor applications have step load and load dump requirements of up to about 70% full load , and these changes can occur within 1 usec.

Monitoring the step load change with a loop and current probe can be problematic. For example, with a 1.0V application and an 11A step load and a monitoring loop inductance of 200nHy; the fastest the load step can be done is in 2.2uSec. Load banks generally have cable inductances of about 1uHy. Hence, an on board dynamic load is needed and the voltage across a load bank resistor monitored to see the magnitude of the load step and how fast the step load is occurring.

The on board dynamic load Q151 with R156-8 was adjusted to give a dynamic step of 11A for a 1.0V output with step and dump times set to be about ½ usec. R160 was set at 100 ohms to set speed of load dump and R155 at 49.9 ohms to set speed of load application. The 3 series load resistors R156-7-8 were set each at 27 mOhms which along with 10 mOhms between wiring, Q151 and R159 give an overall resistance of 90 mOhms. This yields 11A off 1.0Vout. This load is applied for 1.36mSec (measured) every 15.6msec (measured) for a duty cycle of 8.7%.

Based upon the added power drawn off the 5V source when the dynamic load is turned on and the duty cycle and an assumed incremental efficiency of 85% I also got a 11A step load. The following waveforms on the dynamic load resistor closest to channel 1 Vout further confirm the 11A step and also show the speed of load application and removal.

On the next page are detailed waveforms across a load resistor used to confirm the step load to be 11 A, and the time of the load change to be under 1 usec; whether a load step or a load dump.

The following page shows the output voltage of channel one when the step load of 11A is applied, both starting at 1 A load and starting at 4 a load.

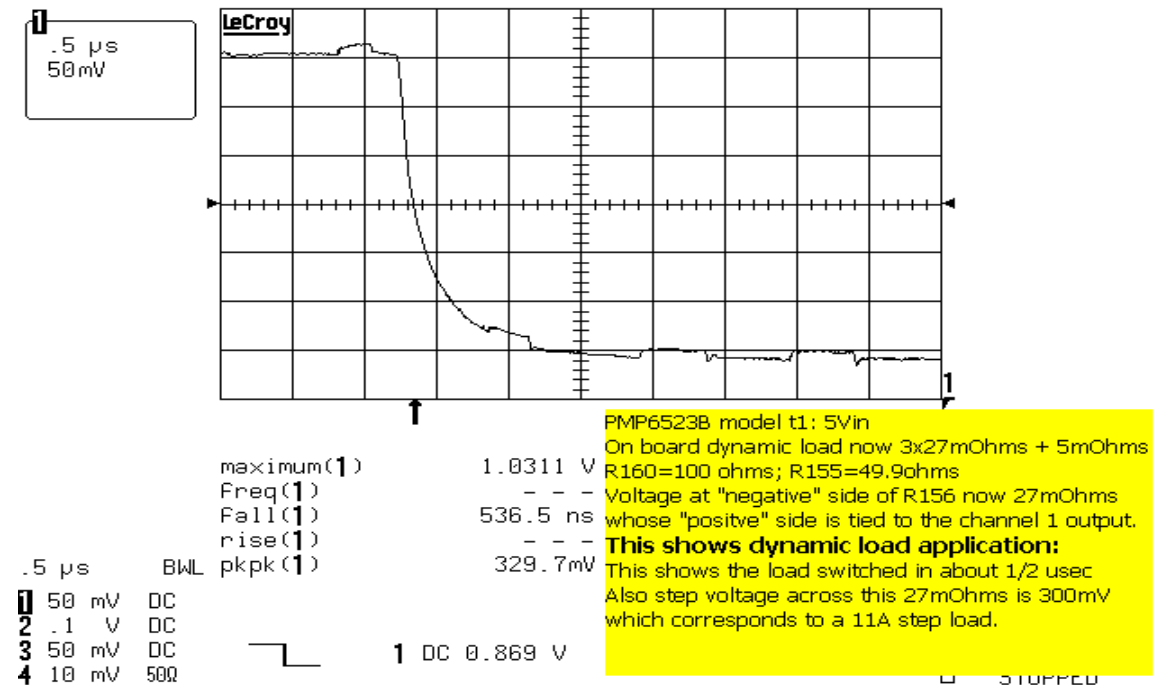
The last page shows the load dump response of 11A, both starting at 12 A and starting at 15 A.

In general the peak overshoot / undershoot was 50mV with recovery to within 20mV in 10 usec.

Resistor R156 monitored during load application:

1-Apr-11

14:38:06

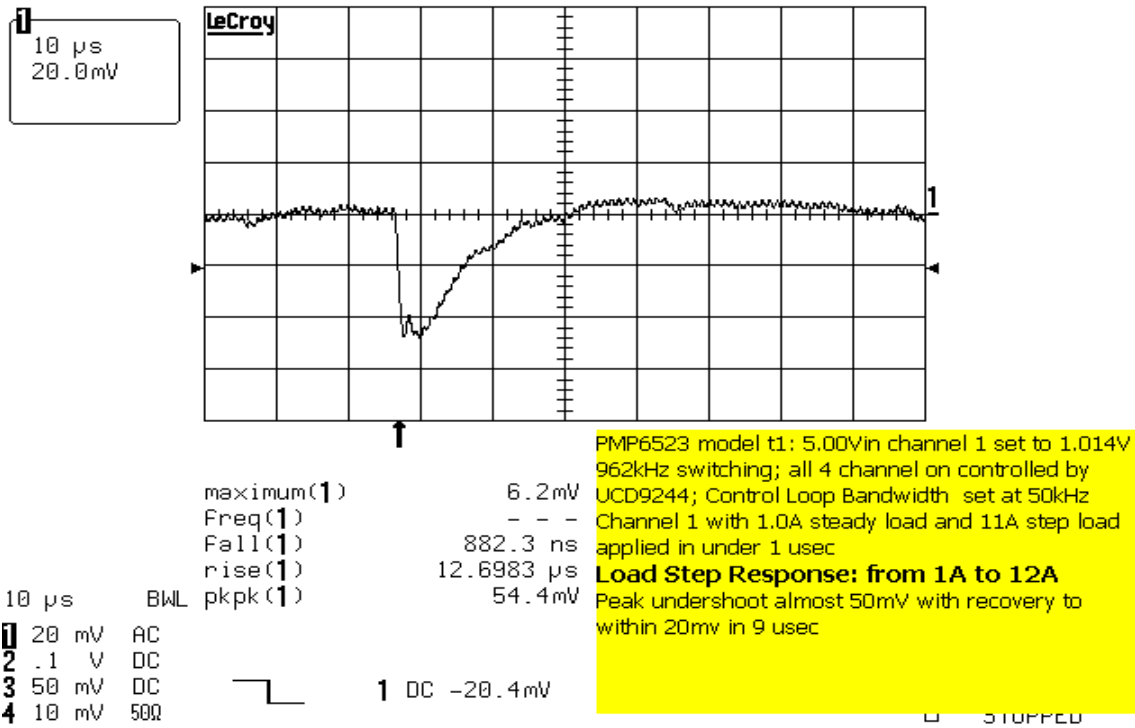


Qq

And now during load removal:

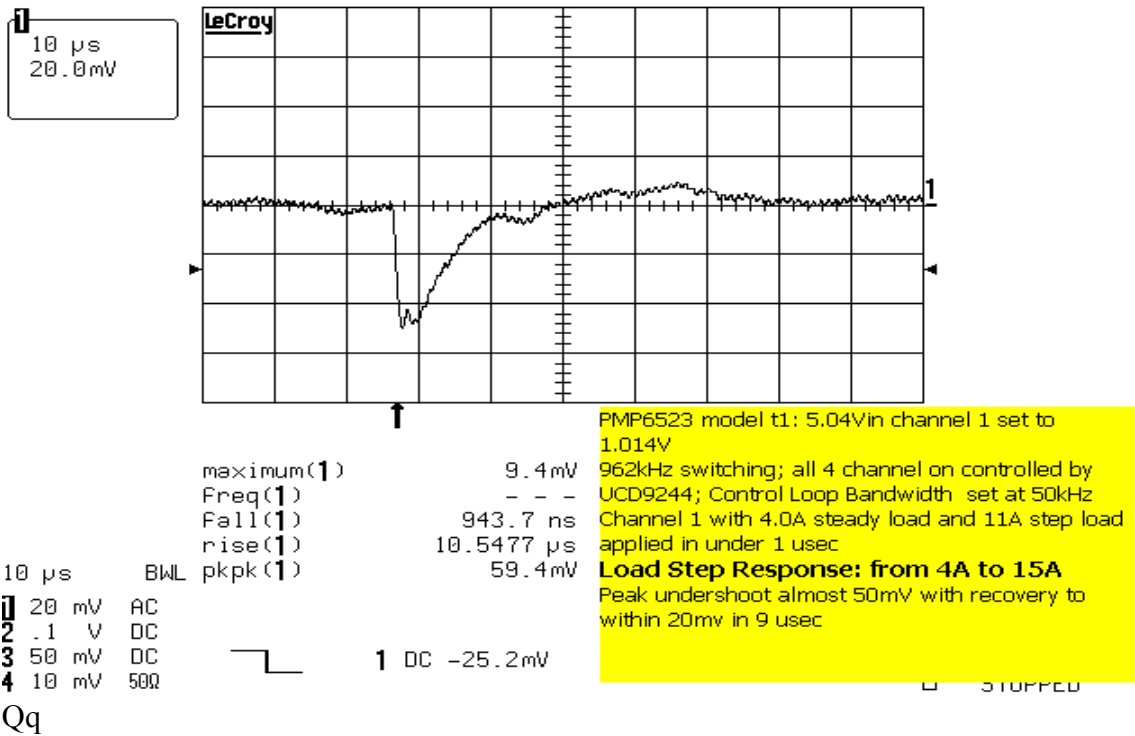
Now the actual output dynamics on channel 1 set at 1.014Vout:

1-Apr-11
14:50:21



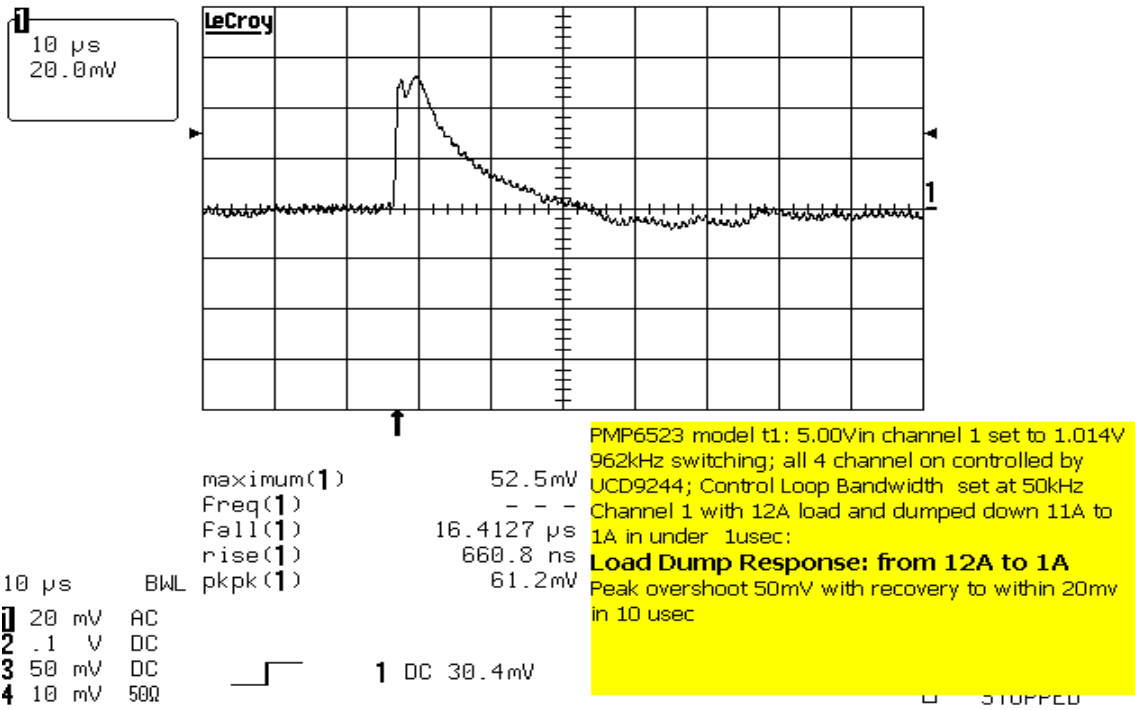
Now load step from 4A to 15A, the full load:

1-Apr-11
14:43:59

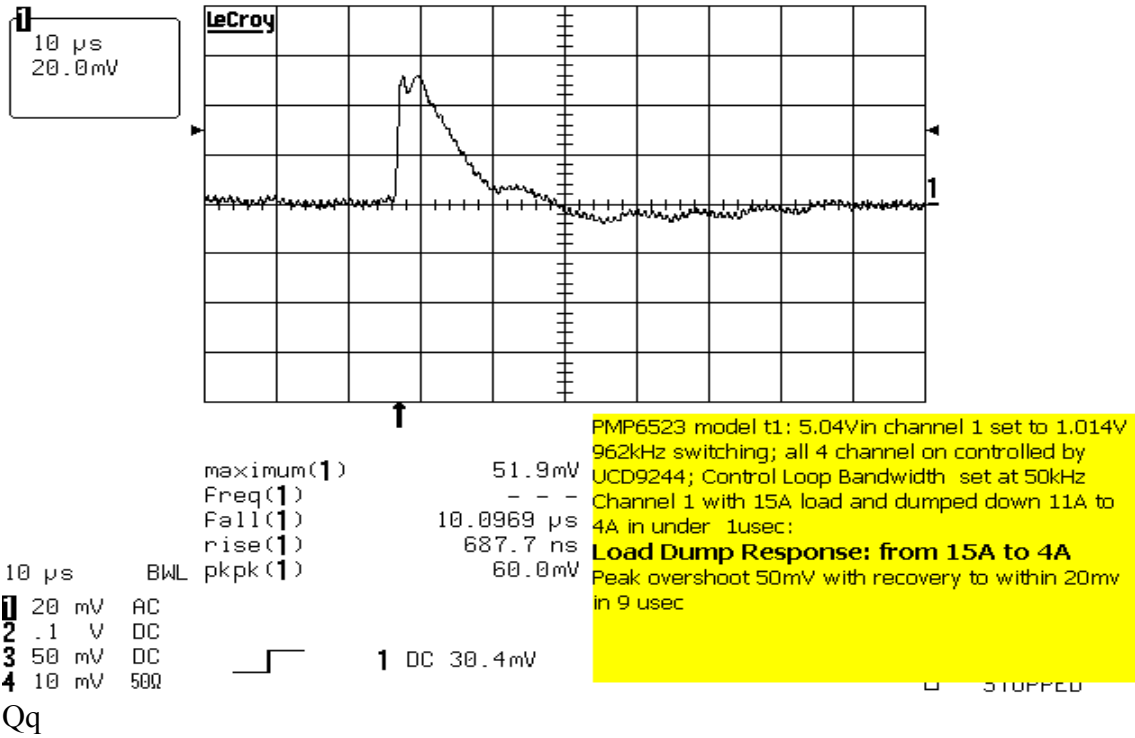


Now the load dumps: from 12A to 1A:

1-Apr-11
14:48:12



1-Apr-11
14:46:14



Qq

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Transportation and Automotive	www.ti.com/automotive
Video and Imaging	www.ti.com/video
Wireless	www.ti.com/wireless-apps

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2011, Texas Instruments Incorporated